

# Fast electronics /detector options

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EIC Polarimetry working group

# Improving speed of detectors

- For faster repetition rates, it is desirable to have detector response faster than bunch frequency ( relevant for electron and ion polarimetry)
- Can have very segmented detector
- Solid state detector actually fast collection time but small charge, typically need shaping and high gain amplification
- Need to be close from detector for best signal to noise ratio and timing resolution

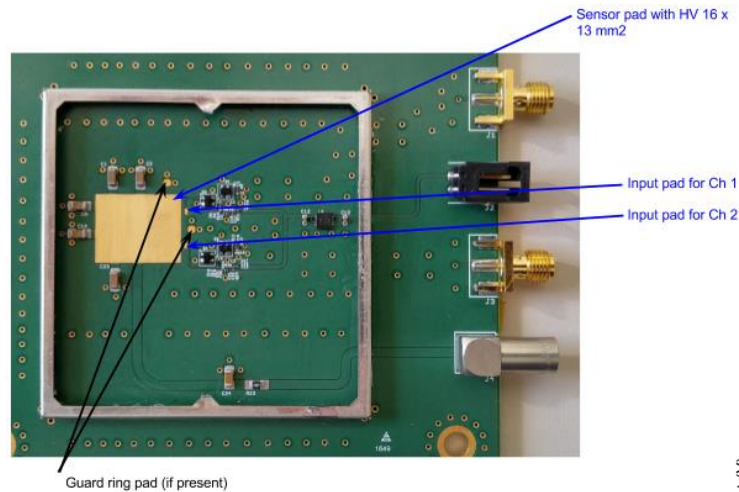
# Detectors side

- Detector options
  - Silicon
  - MAPS
  - Diamond
  - LGAD
- Fast preamplifiers
  - TOTEM Kansas preamp
  - Alphacore preamp:
    - ASIC 8 channels
  - VMM3 chip ( designed for GEM / Micromegas )
    - 64 channels

# Electronics for very fast detectors

## TOTEM electronics designed by Kansas University

A two channels board was designed and manufactured for the characterization of different solid state detectors.



The board was optimized to achieve a good time precision with different sensors, however it can be modified to have an output signal shorter (but less precise)

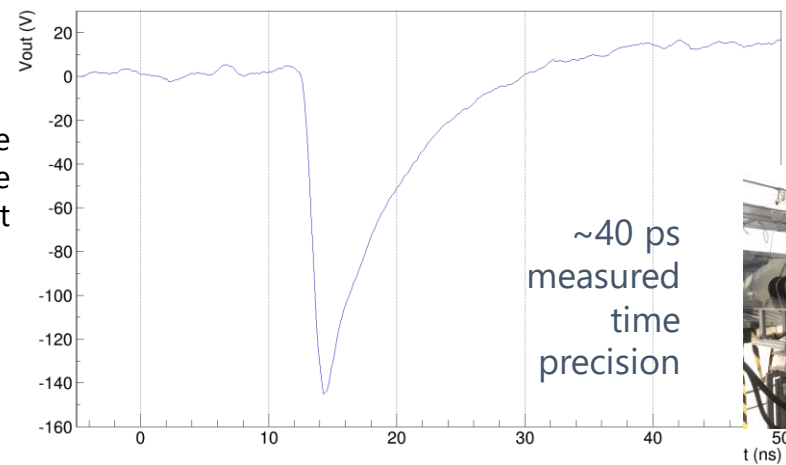
[Test of Ultra Fast Silicon Detectors for Picosecond Time Measurements with a New Multipurpose Read-Out Board](#)

Sensors up to 16x13 mm<sup>2</sup> can be glued and bonded.

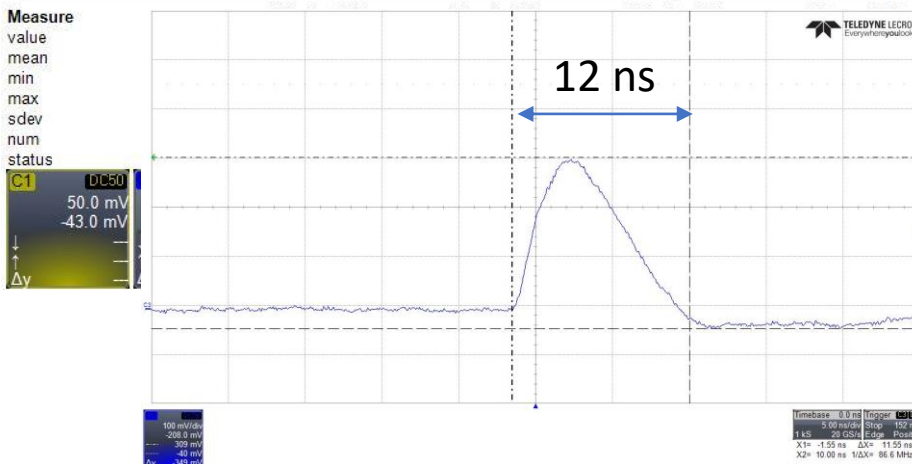
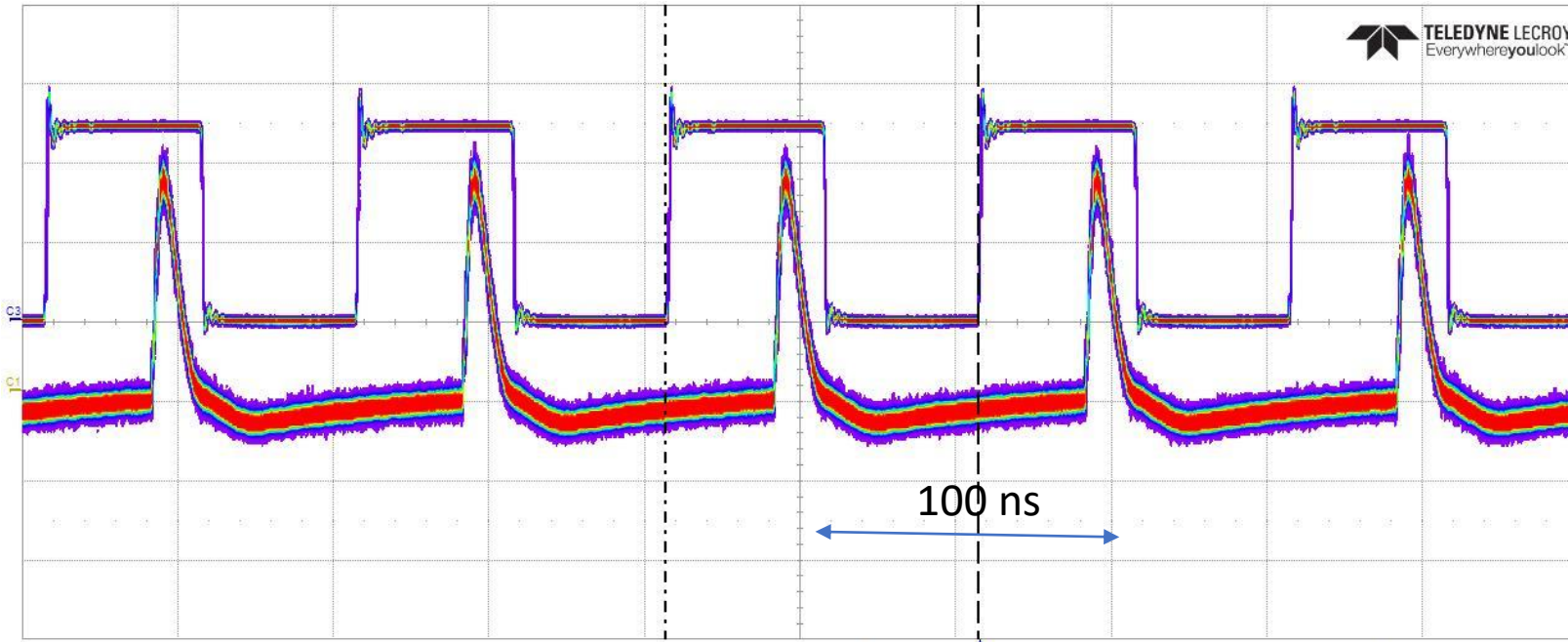
The components can be easily adapted to accommodate:

- Diamond sensors: ~1 nA bias current, both polarities, small signal
- Silicon sensors: ~100 nA bias current, small signal
- UFSD ~100 nA bias current, ~ larger signal
- SiPM: ~ 5 uA bias current, large signal

3x3 mm<sup>2</sup>  
UFSD  
MIP beam  
test @  
Fermilab



# Silicon pulsed with laser at 10 MHz

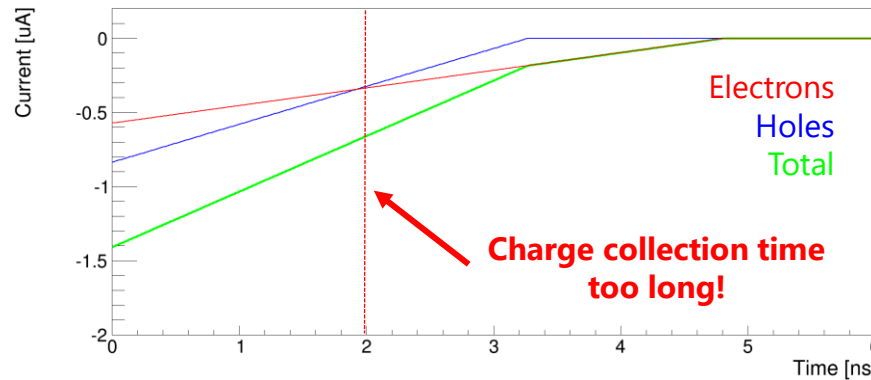


**Amplifier with silicon detector  
fast enough to separate  
successive sources for eRHIC Linac  
Ring at 10 MHz**

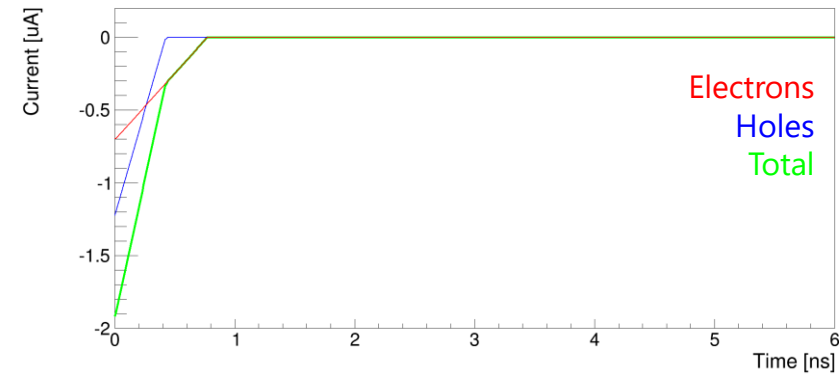
(New proposal for up to 476 MHz )

# Fast detector R&D

Diamond sensors are among the fastest available



500  $\mu\text{m}$  scCVD diamond  
@ 800V



80  $\mu\text{m}$  scCVD diamond @  
500V

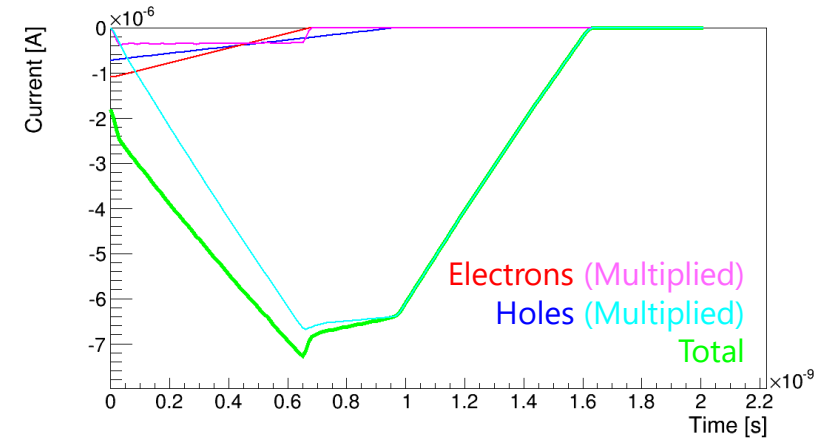
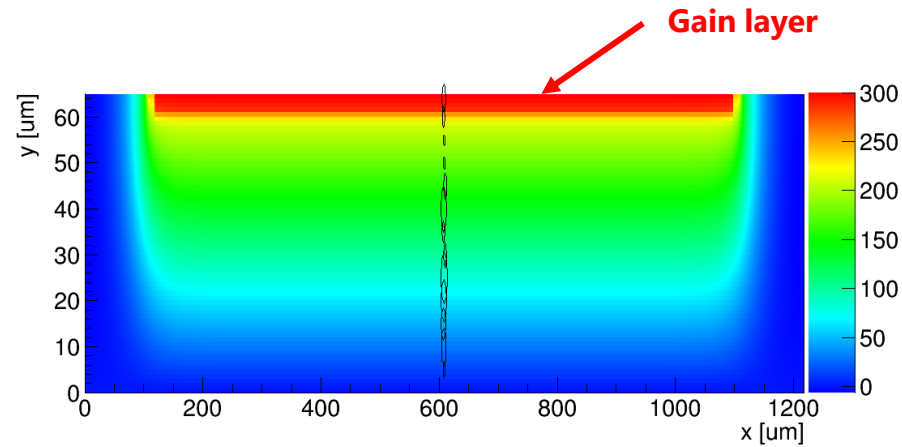
The collection time  $t_c$  depends on the thickness  $d$   $t_c \sim d/v_s$

NOTE: the collected charge  $Q_c = \int i(t) dt$  also depends on the thickness  $d$   $Q_c \sim d$

However, the deep current mainly depends on the carriers' velocities, i.e. electric field  $|i_{MAX}| \sim Q_c/t_c$

# Fast detector R&D

Ultra Fast Silicon Detectors: as fast as diamond, but with a gain layer!

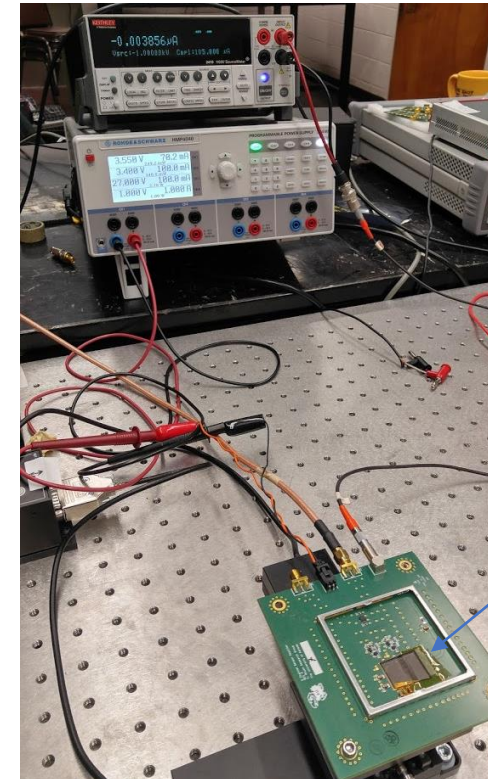
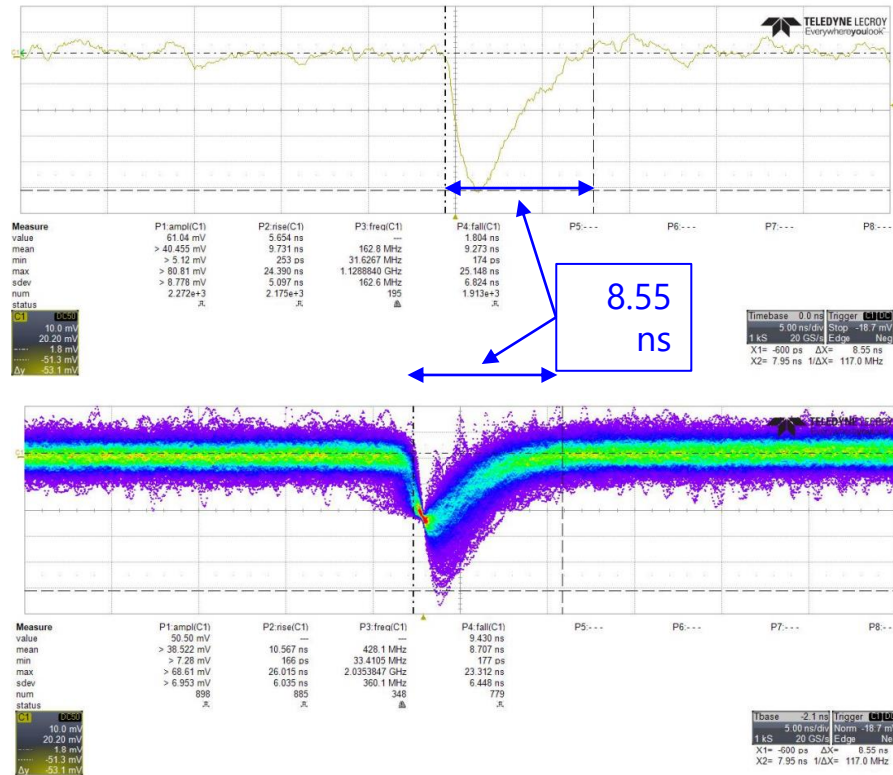


UFSD: 50 μm LGAD

Fast collection time (50 μm thick) and larger signals, thanks to the gain layer

# Electronics for very fast detectors

This board was also used to test the performance of a diamond sensor using a  $\text{Sr}^{90}$   $\beta^-$  source.

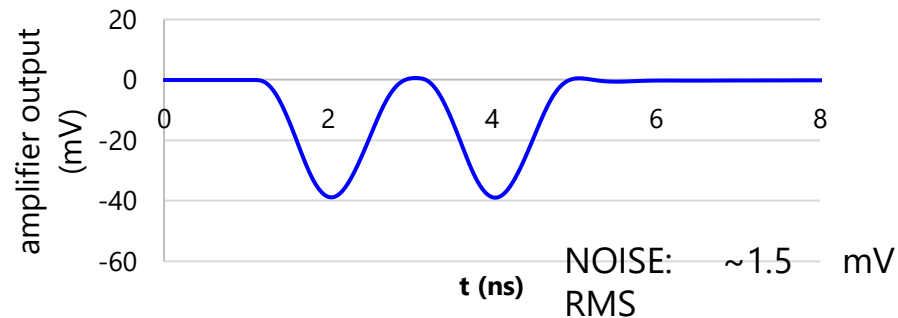
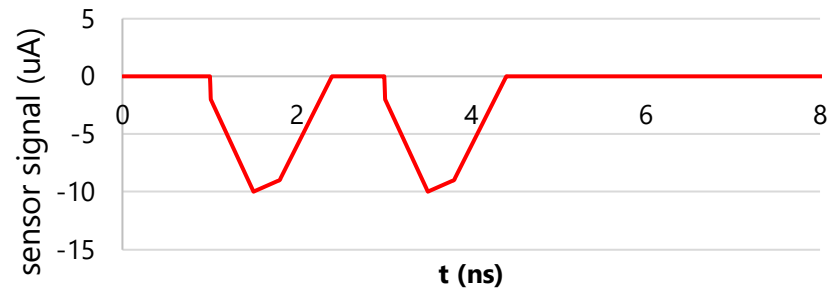




# Fast detector R&D

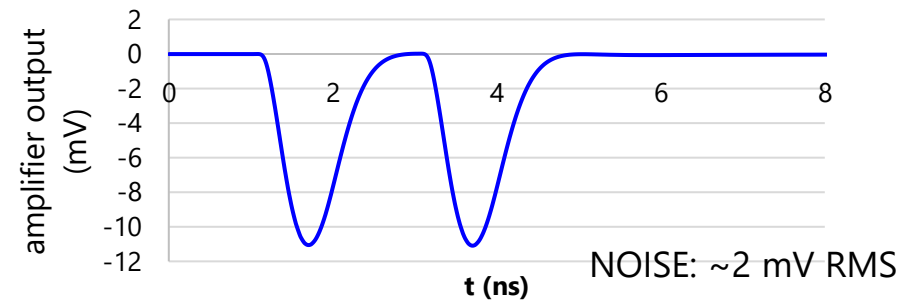
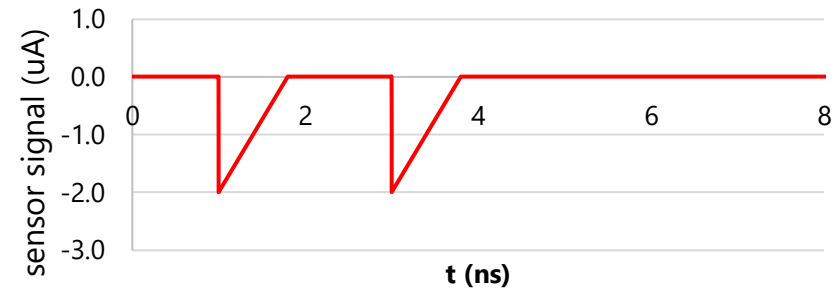
Simulated results:

UFSD



SNR ~  
25

80  $\mu$ m scCVD diamond sensor



SNR ~  
5

Study by Nicola Minafra

# Integrated ASIC

- Was looking at VMM3 chip
  - Gain : 0.5,1,3,4,4.5,6,9,12,16 mV/fC
  - Integration time : 25,50,100,200 ns
  - Possibility for triggering
  - Different reading mode
    - Multiplexed analog amplitude and timing
    - Digitized 10 bit amplitude 20 bit timestamp
    - ART ( streaming mode )

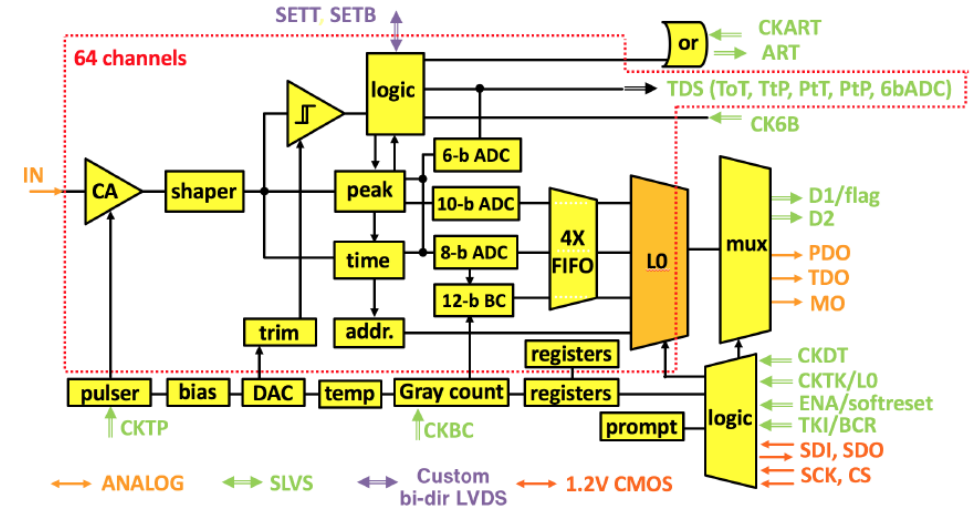


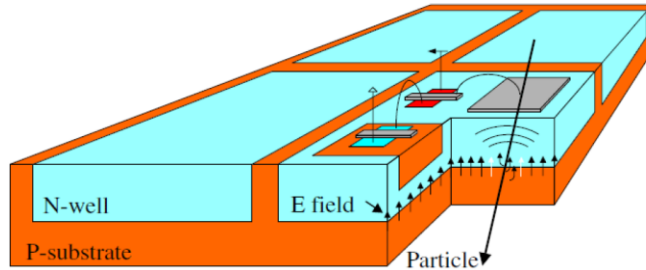
Figure 1: Architecture of VMM3.



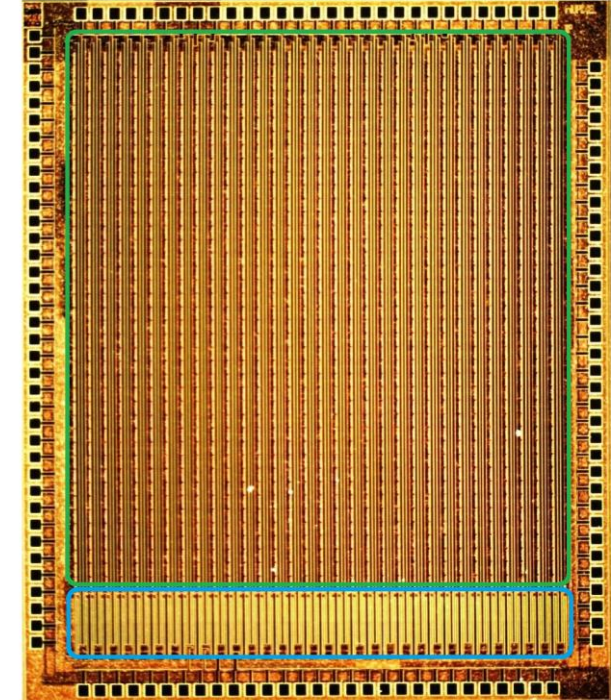
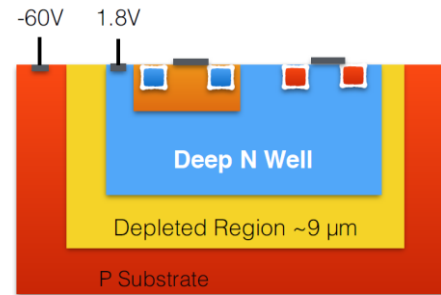
# MAPS option

- Silicon detector can be thinned up to 80  $\mu\text{m}$
- Integrated analog and digital electronics
- Well adapted for pixelized detector since less external electronics
- Cons : not sure about energy resolution, mostly optimized for timing but chip detector could be tailored to need

# HV MAPS



- Pixellized detector MuPix for Mu3e
- 80  $\mu\text{m}$  x 80  $\mu\text{m}$  x 50  $\mu\text{m}$
- Electronics in integrated with pixel (amplification and readout )
- Being investigated by University of Manitoba
- Timing resolution around 16 ns
- 380 Mrad radiation hardness
- Should work in vacuum
- Might work at low temperature



32x40 pixels Mupix4

# Sampling chips

- Analog sampling
  - PSEC4, DRS4 : 1 to 10 GSps 8 channels
  - ASOC : 1 to 3 GSps 4 channels
  - AARDVARC : 10 to 14 Gsps 4 channels 12 bits
- FADCs :
  - JLAB FADC : 250 MHz 12 bit 16 channels
  - Alphacore ASIC : 10 bit 0.5,1,3 Gsps 6 bit 10 Gsps
  - CAEN, Struck :
    - 250 MHz 14 bit 8 or 16 channels
    - 500 MHz 14 bit 8 or 16 channels
    - 1 GHz to 2 GHz 10 bit
    - 4 GHz 10 bit 2 channels